TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (High Speed U-MOSII)

TPC8105-H

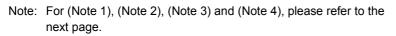
High Speed and High Efficiency DC–DC Converters Lithium Ion Battery Applications Notebook PCs

Portable Equipment Applications

- Small footprint due to small and thin package
- High speed switching
- Small gate charge : Qg = 32 nC (typ.)
- Low drain-source ON resistance $: R_{DS} (ON) = 20 \text{ m}\Omega (typ.)$
- High forward transfer admittance : $|Y_{fs}| = 12 S (typ.)$
- Low leakage current $: I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -30 \ V)$
- Enhancement-mode : V_{th} = -0.8~-2.0 V (V_{DS} = -10 V, I_D = -1 mA)

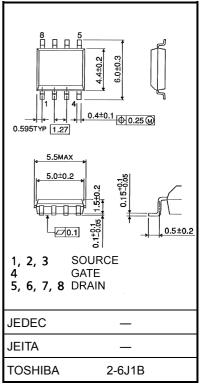
Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	-30	V	
Drain-gate voltage (R	R _{GS} = 20 kΩ)	V _{DGR}	-30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	-7	A	
Drain current	Pulse (Note 1)	I _{DP}	-28		
Drain power dissipati	on (t = 10 s) (Note 2a)	PD	2.4	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	PD	1.0	W	
Single pulse avalancl	ne energy (Note 3)	E _{AS}	63.7	mJ	
Avalanche current		I _{AR}	-7	A	
Repetitive avalanche	energy Note 2a) (Note 4)	E _{AR}	0.24	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	−55 to 150	°C	



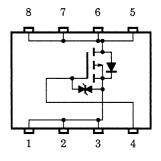
This transistor is an electrostatic sensitive device. Please handle with caution.





Weight: 0.080 g (typ.)

Circuit Configuration

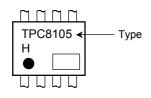


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Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	52.1	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	125	°C/W

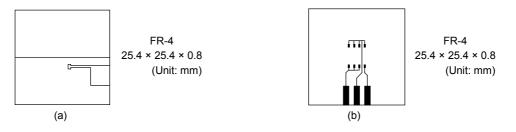
Marking (Note 5)



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:

(a) Device mounted on a glass-epoxy board (a)



(b) Device mounted on a glass-epoxy board (b)

Note 3: V_DD = -24 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 $\Omega,$ I_AR = -7 A

Note 4: Reptitve rating; pulse width limited by maximum channel temperature.

Note 5: on lower left of the marking indicates Pin 1.

shows Lot number. (year of manufacture: last decimal digit of the year of manufacture, month of manufacture: january to december are denoted by letters A to L respectively)

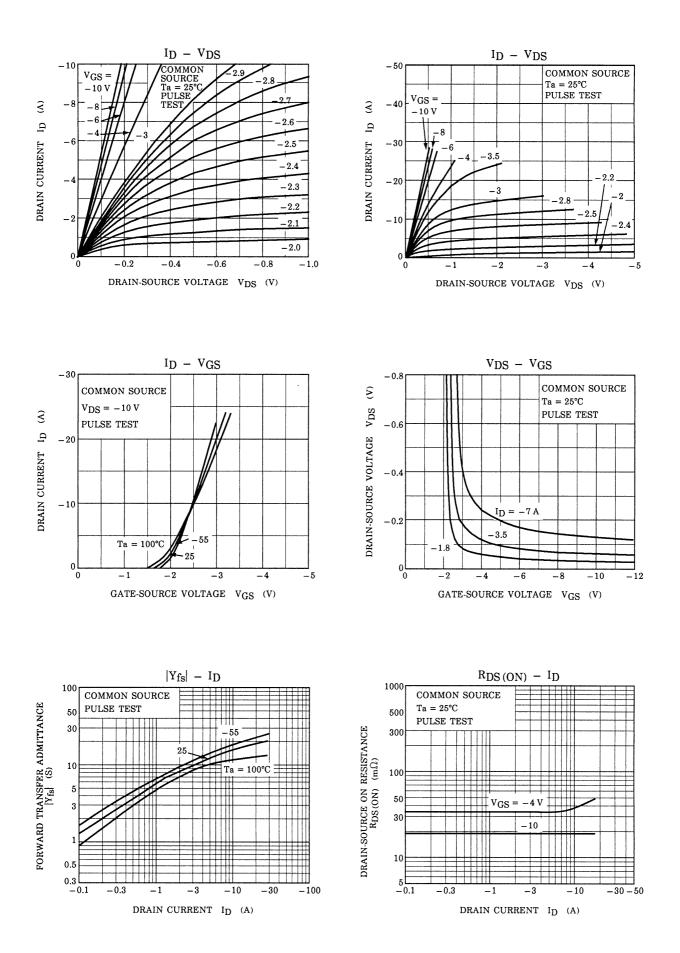
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V_{DS} = -30 V, V_{GS} = 0 V		—	-10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_{\rm D}$ = -10 mA, $V_{\rm GS}$ = 0 V	-30	—		v
		V (BR) DSX	$I_{\rm D}$ = -10 mA, $V_{\rm GS}$ = 20 V	-15	—	_	v
Gate threshold	voltage	V _{th}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8	_	-2.0	V
Drain-source ON resistance		R _{DS (ON)}	V _{GS} = -4 V, I _D = -3.5 A		34	60	mΩ
		R _{DS (ON)}	V _{GS} = -10 V, I _D = -3.5 A		20	40	
Forward transfe	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -3.5 A	5.9	12	_	S
Input capacitant	ce	C _{iss}		_	1440		
Reverse transfer capacitance		C _{rss}	V _{DS} = −10 V, V _{GS} = 0 V, f = 1 MHz	_	330		pF
Output capacitance		C _{oss}		_	485		
Switching time	Rise time	tr	$V_{GS} \xrightarrow{0 V} I_{D} = -3.5 A$ $V_{OUT} \xrightarrow{V_{OUT}} R_{L} = 4.3 \Omega$ $V_{DD} = -15 V$ $Duty \le 1\%, t_{W} = 10 \mu s$	_	10	_	
	Turn-on time	t _{on}		_	18		20
	Fall time	t _f			50		ns
	Turn-off time	t _{off}		—	140	—	
Total gate charge (Gate-source plus gate-drain)		Qg		_	32	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ −24 V, V _{GS} = −10 V, I _D = −7 A	_	23	—	nC
Gate-drain ("miller") charge		Q _{gd}		—	8	—	

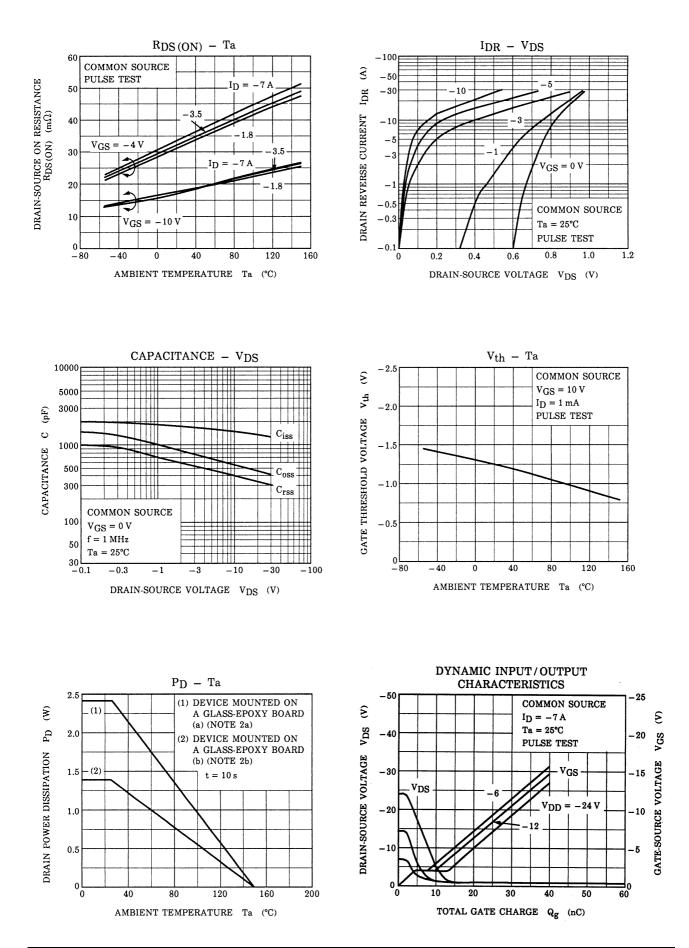
Source–Drain Ratings and Characteristics (Ta = 25°C)

Charact	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	-	-	-28	А
Forward voltage	(diode)	V _{DSF}	I _{DR} = -7 A, V _{GS} = 0 V	_	_	1.2	V

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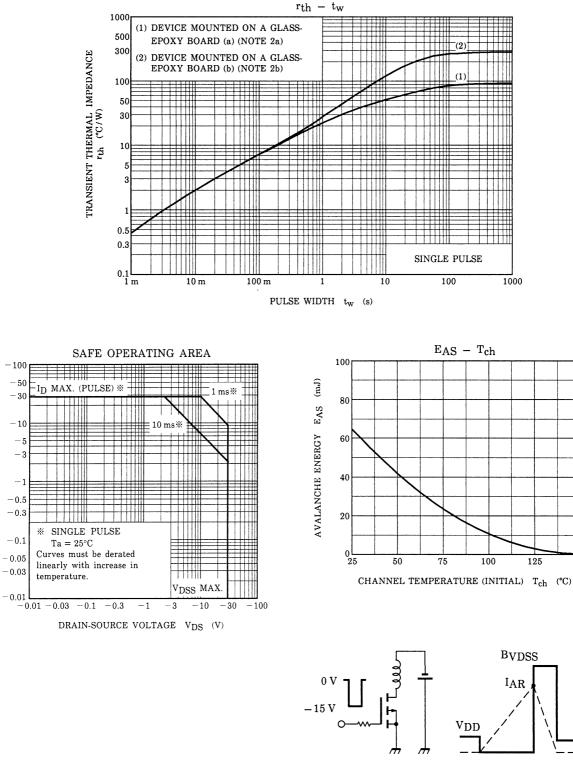
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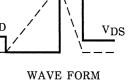
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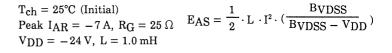
DRAIN CURRENT



TEST CIRCUIT



150



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